

Applicant

Chika Amishima, et al.

Serial No.

10/583,644

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Filed

June 20, 2006

For

POLYAMIDE ACID RESIN UNSATURATED GROUP,

CONTAINING PHOTOSENSTIVE RESIN

COMPOSITION USING

SAME,

AND CURED

PRODUCT THEREOF

Examiner

Fang, Shane

Art Unit

1796

Confirmation

No.

3737

Attorney

Docket No.

576P091

Customer No.

42754

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commusioner For Palents P.O. Box 1450, Alexandra, UAZZ313-1450

Name of applicant, assignee, or Registered

Representative

Signature

Sir:

AMENDMENT

In response to the Office Action dated May 12, 2009, Please amend the above-identified application as follows:

Remarks begin on page 2 of this paper.

Amendments to the claims begin on page 14 of this paper.

An Appendix, containing a partial translation of JP2001-192431, begins on page 21 of this paper.